

## Description

### JMT P-channel Enhancement Mode Power MosFET

#### Features

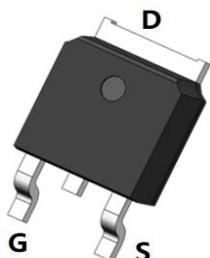
- -30V, -60A  
 $R_{DS(ON)} < 6.5\text{m}\Omega @ V_{GS} = -10\text{V}$   
 $R_{DS(ON)} < 10\text{m}\Omega @ V_{GS} = -4.5\text{V}$
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free

#### Applications

- Load Switch
- PWM Application
- Power Management



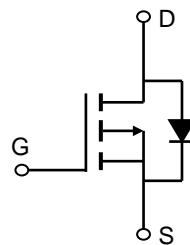
100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



TO-252-3L(DPAK) Top View

Marking and Pin Assignment

Schematic Diagram



#### Package Marking and Ordering Information

Device Marking	Device	Outline	Package	Reel Size	Reel(pcs)	Per Carton (pcs)
JMTK080P03A	JMTK080P03A	TAPING	TO-252-3L	13"	2500	25000

#### Absolute Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		-30	V
$V_{GS}$	Gate-to-Source Voltage		$\pm 20$	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ\text{C}$	-60	A
		$T_C = 100^\circ\text{C}$	-38	
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>		-240	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>		156	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ\text{C}$	78	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>		32	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.6	
$T_J, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	$^\circ\text{C}$

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

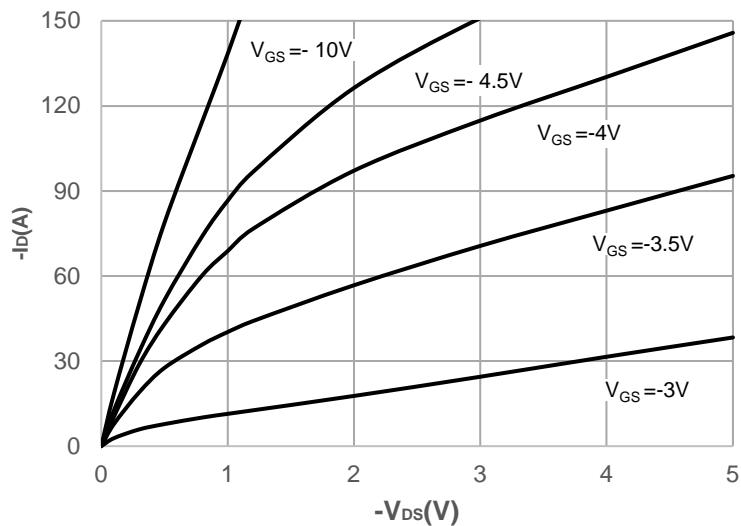
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$	-30	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.0	-1.8	-2.5	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = -10\text{V}, I_D = -20\text{A}$	-	5.0	6.5	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -10\text{A}$	-	7.8	10	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$	-	3366	-	pF
$C_{\text{oss}}$	Output Capacitance		-	471	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	324	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } -10\text{V}$ $V_{DS} = -15\text{V}, I_D = -10\text{A}$	-	59	-	nC
$Q_{\text{gs}}$	Gate Source Charge		-	10	-	nC
$Q_{\text{gd}}$	Gate Drain("Miller") Charge		-	14	-	nC
<b>Switching Characteristics</b>						
$t_{d(\text{on})}$	Turn-On Delay Time	$V_{GS} = -10\text{V}, V_{DD} = -15\text{V}$ $I_D = -10\text{A}, R_{\text{GEN}} = 3\Omega$	-	7	-	ns
$t_r$	Turn-On Rise Time		-	6	-	ns
$t_{d(\text{off})}$	Turn-Off Delay Time		-	112	-	ns
$t_f$	Turn-Off Fall Time		-	78	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	-60	-	A
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-240	-	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = -30\text{A}$	-	-	-1.2	V
$\text{trr}$	Body Diode Reverse Recovery Time	$I_F = -10\text{A}, dI/dt = 100\text{A/us}$	-	21	-	ns
$Q_{\text{rr}}$	Body Diode Reverse Recovery Charge		-	10	-	nC

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

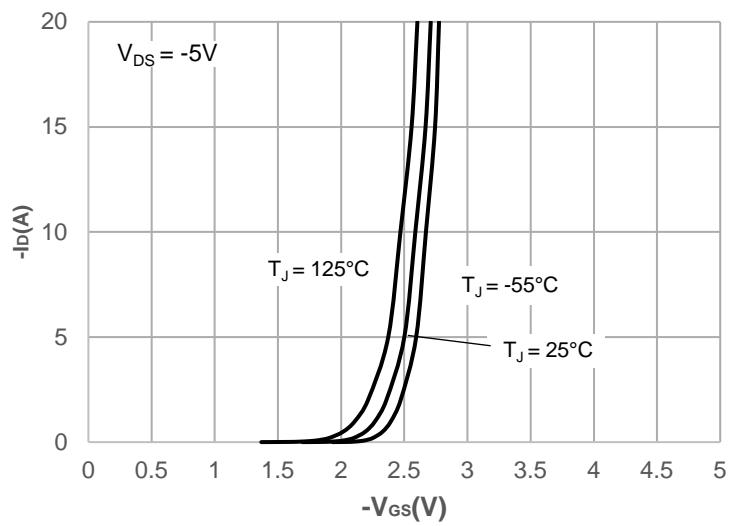
2. EAS condition: Starting  $T_J=25^\circ\text{C}$ ,  $V_{DD}=-15\text{V}$ ,  $V_G=-10\text{V}$ ,  $R_G=25\text{ohm}$ ,  $L=0.5\text{mH}$ ,  $I_{AS}=-25\text{A}$ 3.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Typical Performance Characteristics

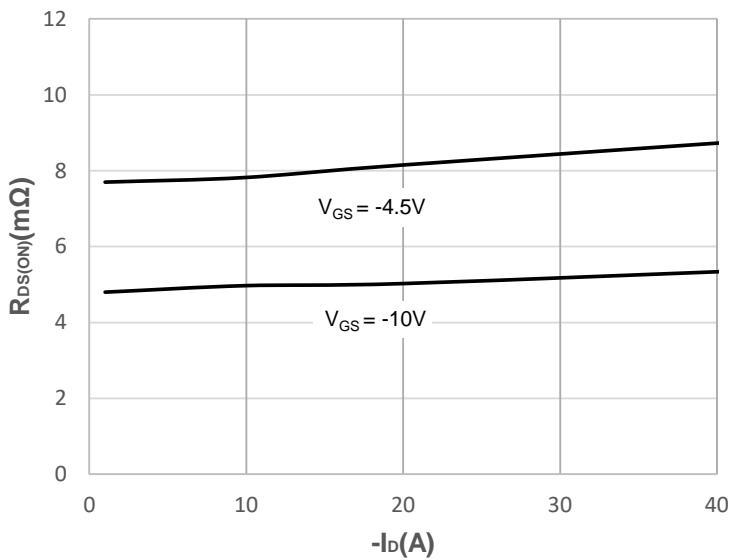
**Figure 1: Output Characteristics**



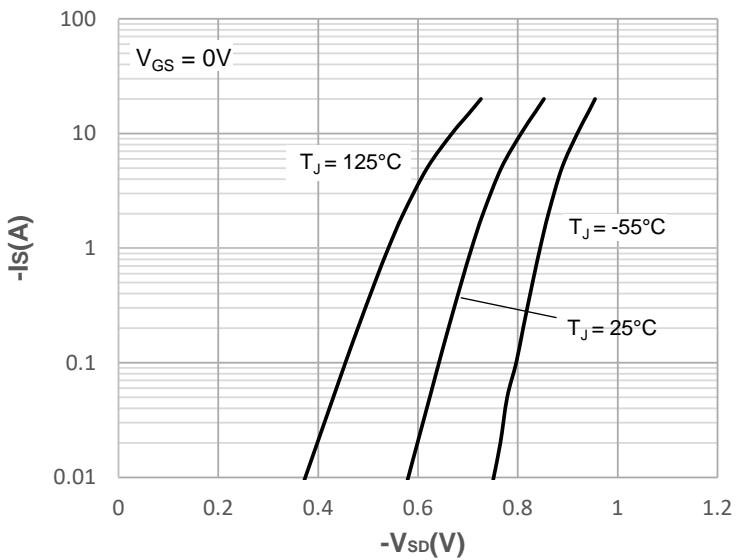
**Figure 2: Typical Transfer Characteristics**



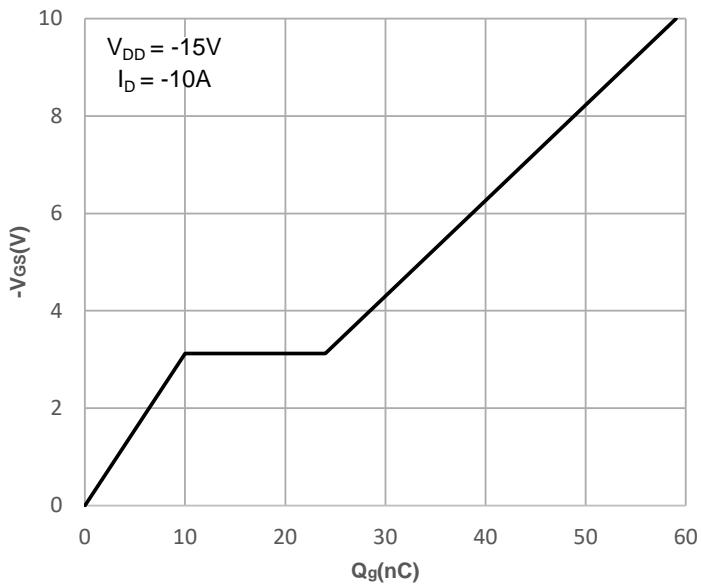
**Figure 3: On-resistance vs. Drain Current**



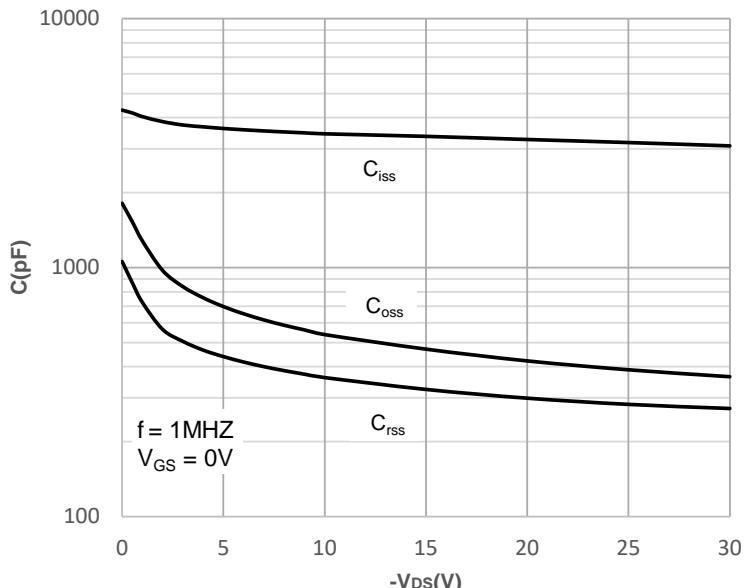
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**

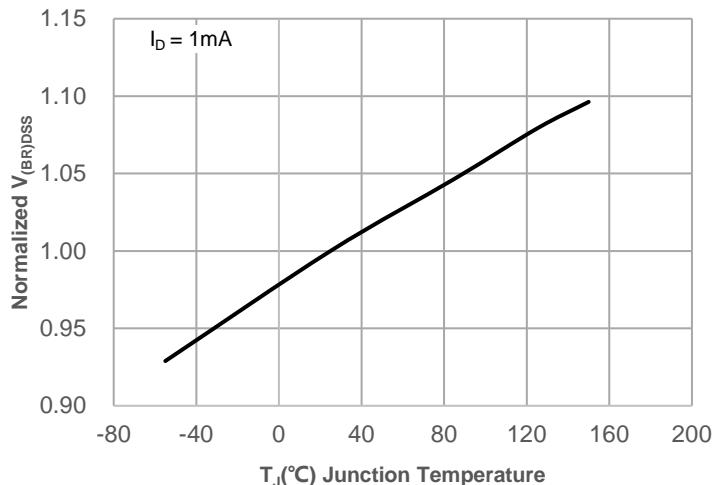


**Figure 6: Capacitance Characteristics**

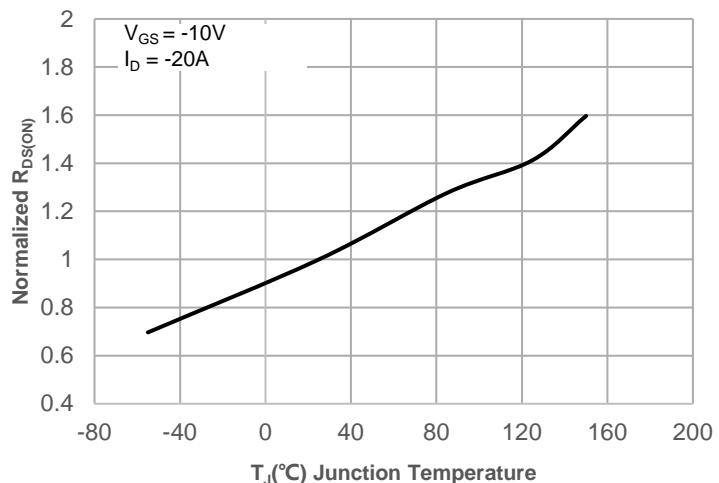


## Typical Performance Characteristics

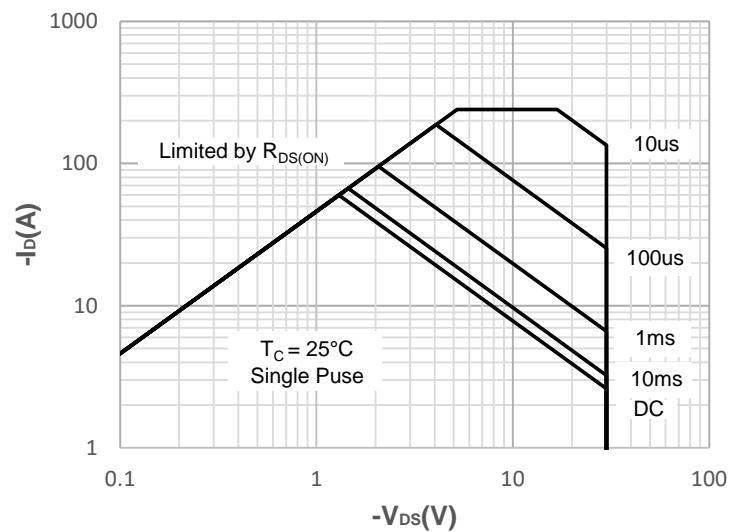
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



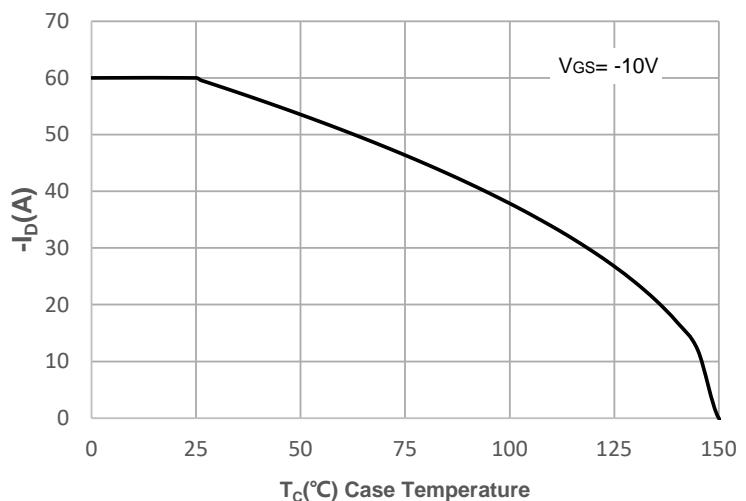
**Figure 8: Normalized on Resistance vs. Junction Temperature**



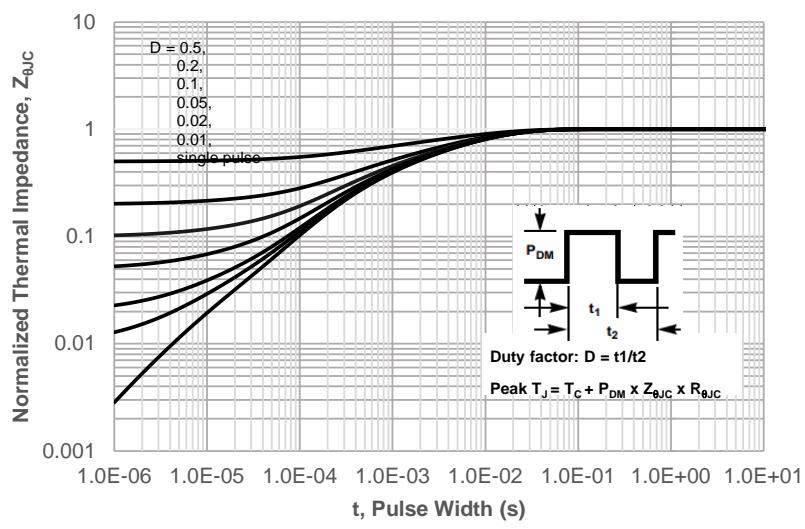
**Figure 9: Maximum Safe Operating Area**



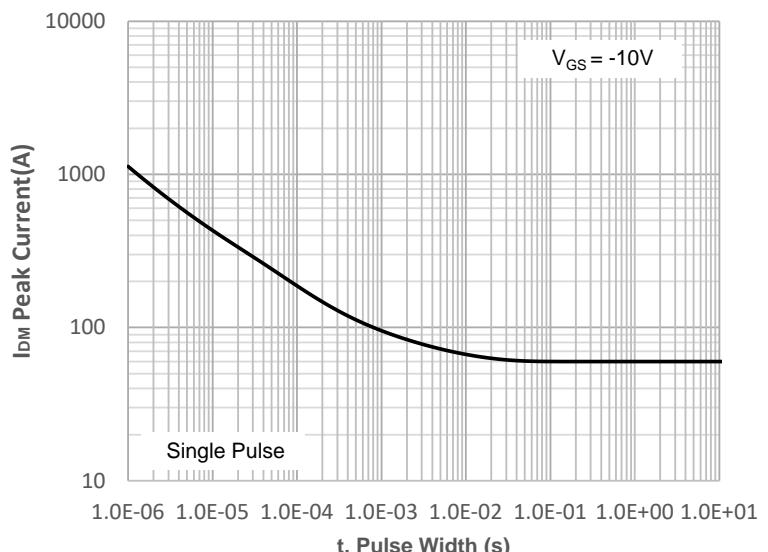
**Figure 10: Maximum Continuous Drain Current vs. Case Temperature**



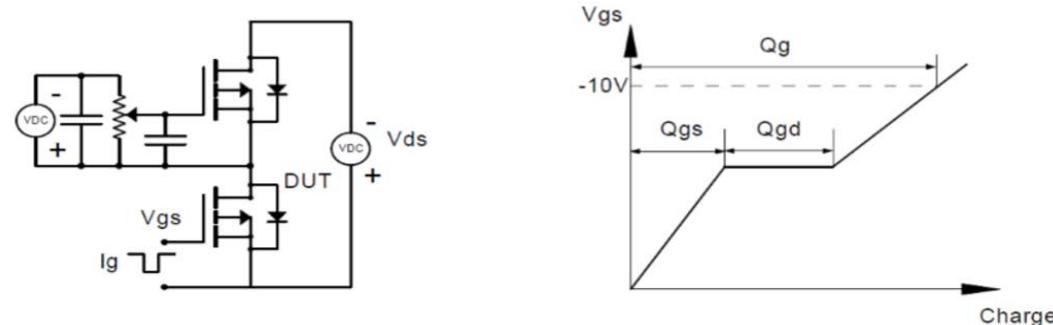
**Figure 11: Normalized Maximum Transient Thermal Impedance**



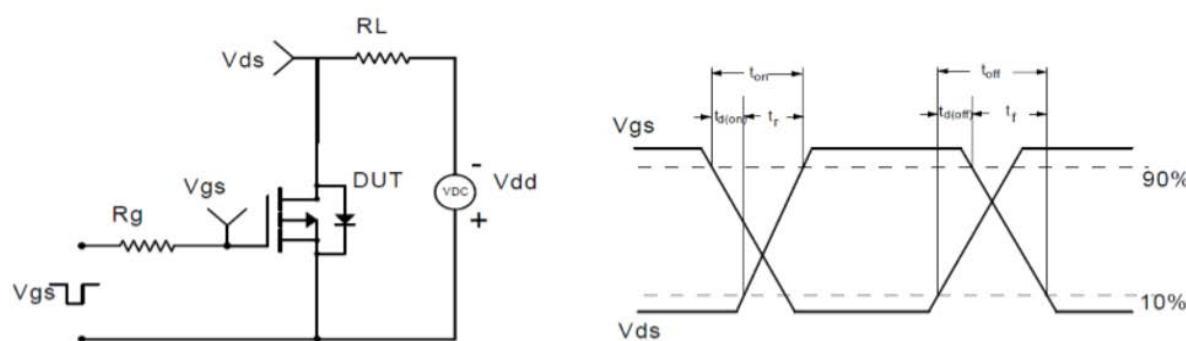
**Figure 12: Peak Current Capacity**



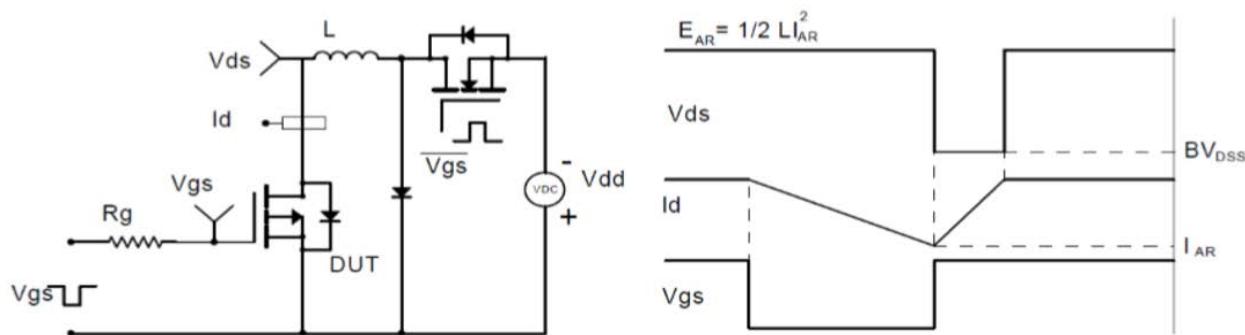
## Test Circuit



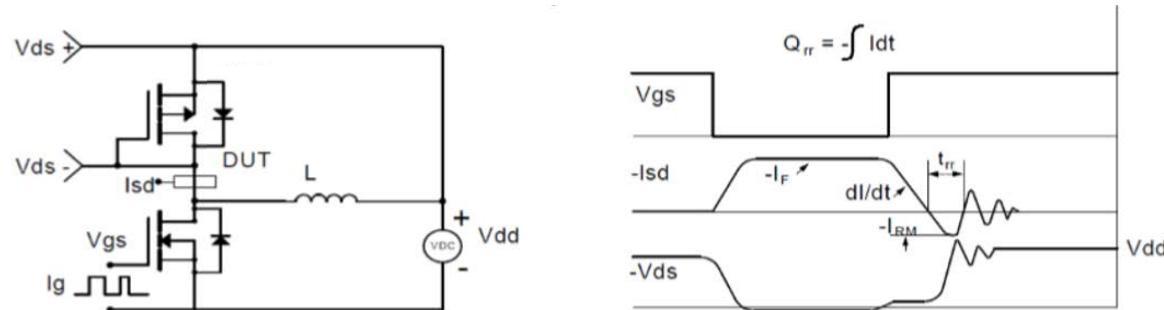
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

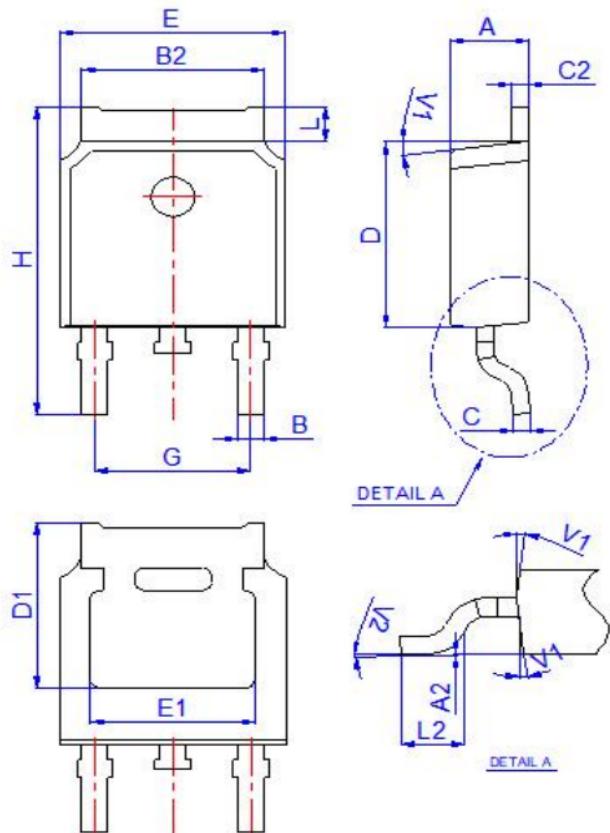


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(TO-252-3L)



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

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